IPC ASSOCIATION CO ELECTRONICS IN	© Copyright 2005. IPC,	<b>Intervial Composition Declaration</b> Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both ternational and Pan-American copyright conventions.		This doc level par	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
upplier I	Information						•							
Company name*			Company unique ID			Unique	Unique ID Authority				Response Date*			
nsemi											2025-05-11			
ontact Nam	ne	Title - Contact			Phone -	Phone - Contact*			Email - Contact*					
roduct-Env	v-Stewards		Product Enviro Compliance			NA	NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone -	Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product			Product Enviro Compliance			NA	NA			Product-Env-Stewards@onsemi.com				
R	Requester Item Number	Mfr Item I	Mfr Item Number Mfr Item Name			Effecti	ve Date	Version	Manufacturing Site	Weight	* UOM	Unit Type		
		NXH200T STNG	Γ120H3Q2F2	80kW Gen-II Q2F TIM(Ni-plated)	PACK-200A Module wit	h 2025-0	)5-11		CNG	175618	.11 mg	Each		
lanufactı	uring Proccess Informatio	n												
Те	Cerminal Plating / Grid Array Material Terminal Base Alloy J		J-STD-020 MSL Rating	SL Rating Peak Process Body Temperature Max Time at Pea				Temperature N	Jumber of Reflow C	ycles				
Matte Tin (Sn) - annealed		CU Alloy NA		NA	0	0 C 30		30	seconds 3					

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a							
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
			Supplier	PBT	26062-94-2		6714.4995	mg
Case Lid	6690.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2341.5	mg
			Supplier	PBT	26062-94-2		4348.5	mg
DBC	17490.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		7293.3301	mg
			В	Nickel (Ni)	7440-02-0		34.98	mg
			Supplier	Copper (Cu)	7440-50-8		10161.6895	mg
Die	219.105	mg	Supplier	Silicon (Si)	7440-21-3		219.105	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	5040.0	mg	Supplier	Silver (Ag)	7440-22-4		327.6	mg
			Supplier	Tin (Sn)	7440-31-5		4712.3999	mg
			Supplier	Copper (Cu)	7440-50-8		-151.2004	mg
Terminal	3540.0	mg	Supplier	Silicon (Si)	7440-21-3		9.558	mg
			В	Nickel (Ni)	7440-02-0		47.79	mg
			Supplier	Copper (Cu)	7440-50-8		3481.7671	mg
			Supplier	Phosphorus (P)	7723-14-0		0.885	mg
Wire Bond - Al	39.0	mg	Supplier	Aluminum (Al)	7429-90-5		39	mg